



**Annexure A**

**Format of the Initial Disclosure to be made by an entity identified as a Large Corporate**

Sr. No.	Particulars	Details
1.	Name of the company	Mold-Tek Packaging Limited
2.	CIN	L21022TG1997PLC026542
3.	Outstanding borrowing of company as on 31st March, 2019 (in Rs. Cr)	Working capital- Rs. 72.81 cr Term Loan- Rs. 18.33 cr Vehicle loans- Rs. 1.97 cr
4.	Highest Credit Rating During the previous FY along with name of the Credit Rating Agency	Long term A (stable) Short term A1 ICRA
5.	Name of Stock Exchange in which the fine shall be paid, in case of shortfall in the required borrowing under the framework	BSE & NSE

We confirm that we are **not** a Large Corporate as per the applicability criteria as specified at para 2.2 given under the SEBI circular SEBI/HO/DDHS/CIR/P/2018/144 dated November 26, 2018.

  
(Signature)  
**Thakur Vishal Singh**  
Company Secretary  
Contact Details: 040-40300323

  
(Signature)  
**Seshu Kumari Adivishnu**  
Chief Financial Officer  
Contact Details: 040-40300325

**Date: 26<sup>th</sup> April, 2019**  
**Place: Hyderabad**



Corporate Office :

Plot # 700, Road No. 36, Jubilee Hills, Hyderabad - 500 033, Telangana, INDIA.  
Phone : +91-40-40300300, Fax : +91-40-40300328, E-mai l: ir@moldtekindia.com  
Website : www.moldtekgroup.com CIN No: L21022TG1997PLC026542